



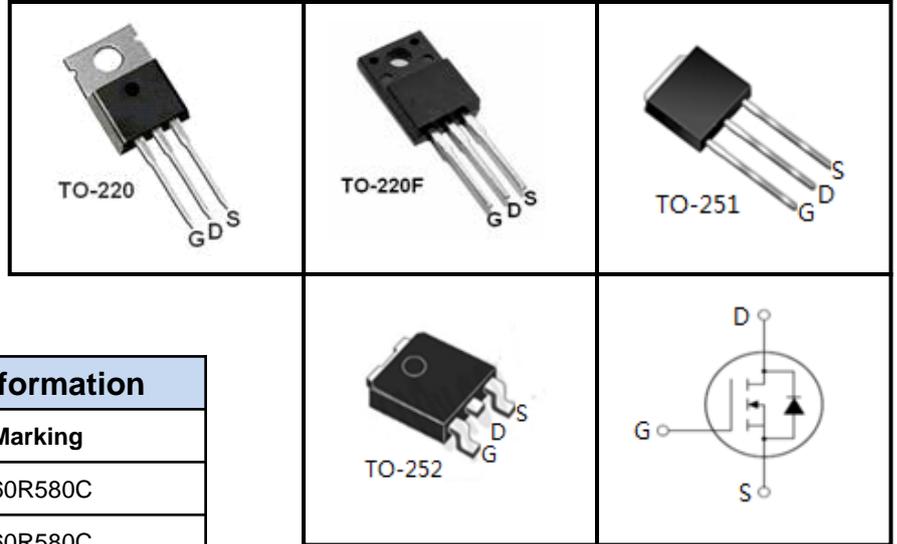
# 600V Super-Junction Power MOSFET

## FEATURES

- Very low FOM  $R_{DS(on)} \times Q_g$
- 100% avalanche tested
- RoHS compliant

## APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)



| Device Marking and Package Information |         |         |
|--|---------|---------|
| Device                                 | Package | Marking |
| TPP60R580C                             | TO-220  | 60R580C |
| TPA60R580C                             | TO-220F | 60R580C |
| TPU60R580C                             | TO-251  | 60R580C |
| TPD60R580C                             | TO-252  | 60R580C |

| Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ , unless otherwise noted |                |          |        |        |         |                  |
|--|----------------|----------|--------|--------|---------|------------------|
| Parameter  | Symbol         | Value    |        |        |         | Unit             |
|  |                | TO-220   | TO-251 | TO-252 | TO-220F |                  |
| Drain-Source Voltage ( $V_{GS} = 0\text{V}$ )                              | $V_{DSS}$      | 600      |        |        |         | V                |
| Continuous Drain Current   | $I_D$          | 7        |        |        |         | A                |
| Pulsed Drain Current (note1)   | $I_{DM}$       | 21       |        |        |         | A                |
| Gate-Source Voltage  | $V_{GSS}$      | $\pm 30$ |        |        |         | V                |
| Single Pulse Avalanche Energy (note2)                                      | $E_{AS}$       | 50       |        |        |         | mJ               |
| Avalanche Current (note1)  | $I_{AR}$       | 7        |        |        |         | A                |
| Repetitive Avalanche Energy (note1)  | $E_{AR}$       | 0.2      |        |        |         | mJ               |
| Power Dissipation ( $T_C = 25^\circ\text{C}$ )                             | $P_D$          | 63       |        |        | 28      | W                |
| Operating Junction and Storage Temperature Range                           | $T_J, T_{stg}$ | -55~+150 |        |        |         | $^\circ\text{C}$ |

| Thermal Resistance                      |            |        |        |        |         |                    |
|---|------------|--------|--------|--------|---------|--------------------|
| Parameter                               | Symbol     | Value  |        |        |         | Unit               |
|   |            | TO-220 | TO-251 | TO-252 | TO-220F |                    |
| Thermal Resistance, Junction-to-Case    | $R_{thJC}$ | 2.0    |        |        | 4.5     | $^\circ\text{C/W}$ |
| Thermal Resistance, Junction-to-Ambient | $R_{thJA}$ | 62     |        |        | 80      |                    |



| Specifications $T_J = 25^\circ\text{C}$ , unless otherwise noted |               |  |       |      |           |          |
|--|---------------|--|-------|------|-----------|----------|
| Parameter  | Symbol        | Test Conditions  | Value |      |           | Unit     |
|  |               |  | Min.  | Typ. | Max.      |          |
| <b>Static</b>  |               |  |       |      |           |          |
| Drain-Source Breakdown Voltage                                   | $V_{(BR)DSS}$ | $V_{GS} = 0V, I_D = 250\mu A$                            | 600   | --   | --        | V        |
| Zero Gate Voltage Drain Current                                  | $I_{DSS}$     | $V_{DS} = 600V, V_{GS} = 0V, T_J = 25^\circ\text{C}$     | --    | --   | 1         | $\mu A$  |
|  |               | $V_{DS} = 600V, V_{GS} = 0V, T_J = 150^\circ\text{C}$    | --    | --   | 100       |          |
| Gate-Source Leakage  | $I_{GSS}$     | $V_{GS} = \pm 30V$                                       | --    | --   | $\pm 100$ | nA       |
| Gate-Source Threshold Voltage                                    | $V_{GS(th)}$  | $V_{DS} = V_{GS}, I_D = 250\mu A$                        | 2.5   | --   | 3.5       | V        |
| Drain-Source On-Resistance (Note3)                               | $R_{DS(on)}$  | $V_{GS} = 10V, I_D = 3A$                                 | --    | 0.50 | 0.58      | $\Omega$ |
| Forward Transconductance (Note3)                                 | $g_{fs}$      | $V_{DS} = 10V, I_D = 3A$                                 | --    | 5.6  | --        | S        |
| <b>Dynamic</b>   |               |  |       |      |           |          |
| Input Capacitance  | $C_{iss}$     | $V_{GS} = 0V,$<br>$V_{DS} = 50V,$<br>$f = 1.0\text{MHz}$ | --    | 486  | --        | $\mu F$  |
| Output Capacitance   | $C_{oss}$     |  | --    | 68   | --        |          |
| Reverse Transfer Capacitance                                     | $C_{rss}$     |  | --    | 4    | --        |          |
| Total Gate Charge  | $Q_g$         | $V_{DD} = 480V, I_D = 7A,$<br>$V_{GS} = 10V$             | --    | 12   | --        | nC       |
| Gate-Source Charge   | $Q_{gs}$      |  | --    | 2.5  | --        |          |
| Gate-Drain Charge  | $Q_{gd}$      |  | --    | 4.5  | --        |          |
| Turn-on Delay Time   | $t_{d(on)}$   | $V_{DD} = 300V, I_D = 7A,$<br>$R_G = 25\Omega$           | --    | 14   | 31        | ns       |
| Turn-on Rise Time  | $t_r$         |  | --    | 32   | 66        |          |
| Turn-off Delay Time  | $t_{d(off)}$  |  | --    | 53   | 109       |          |
| Turn-off Fall Time   | $t_f$         |  | --    | 15   | 32        |          |
| <b>Drain-Source Body Diode Characteristics</b>                   |               |  |       |      |           |          |
| Continuous Body Diode Current                                    | $I_S$         | $T_C = 25^\circ\text{C}$                                 | --    | --   | 7         | A        |
| Pulsed Diode Forward Current                                     | $I_{SM}$      |  | --    | --   | 21        |          |
| Body Diode Voltage   | $V_{SD}$      | $T_J = 25^\circ\text{C}, I_{SD} = 7A, V_{GS} = 0V$       | --    | 0.9  | 1.2       | V        |
| Reverse Recovery Time  | $t_{rr}$      | $V_R = 480V, I_F = I_S,$<br>$di_F/dt = 100A/\mu s$       | --    | 400  | --        | ns       |
| Reverse Recovery Charge  | $Q_{rr}$      |  | --    | 1.5  | --        | $\mu C$  |
| Peak Reverse Recovery Current                                    | $I_{rrm}$     |  | --    | 7    | --        | A        |

**Notes**

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2.  $I_{AS} = 3A, V_{DD} = 50V, R_G = 25\Omega, \text{Starting } T_J = 25^\circ\text{C}$
3. Pulse Test: Pulse width  $\leq 300\mu s, \text{Duty Cycle } \leq 1\%$



Typical Characteristics  $T_J = 25^\circ\text{C}$ , unless otherwise noted

Figure 1. Output Characteristics

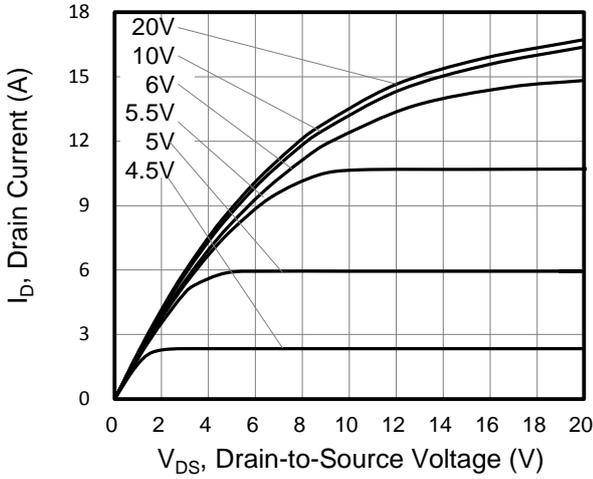


Figure 2. Transfer Characteristics

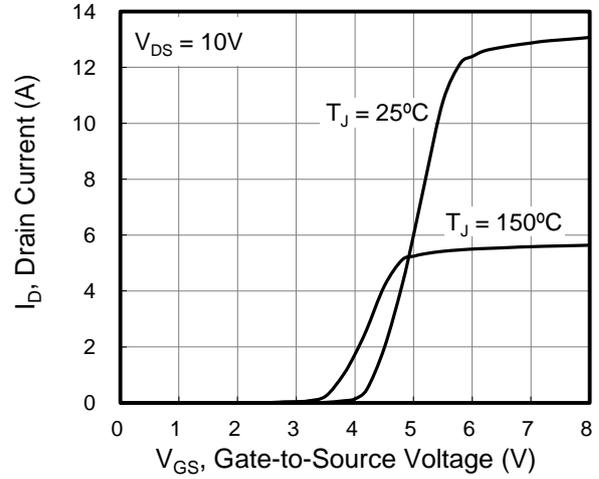


Figure 3. On-Resistance vs. Drain Current

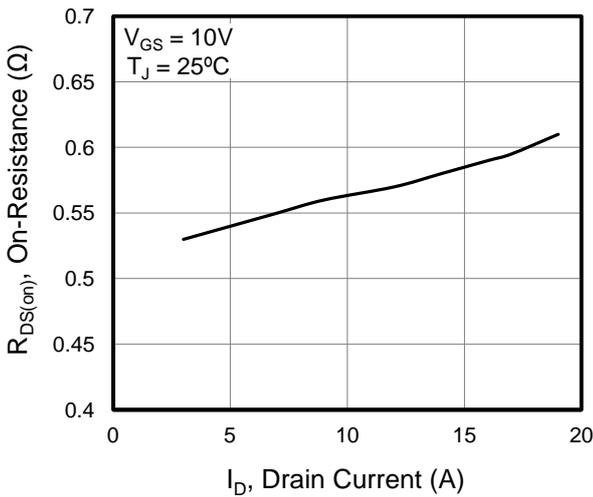


Figure 4. Capacitance

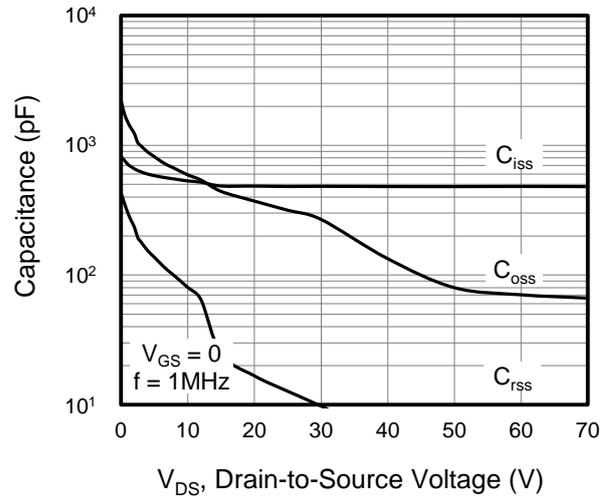


Figure 5. Gate Charge

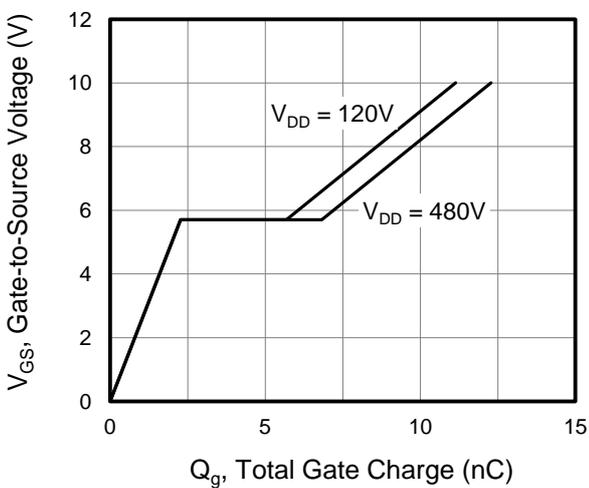
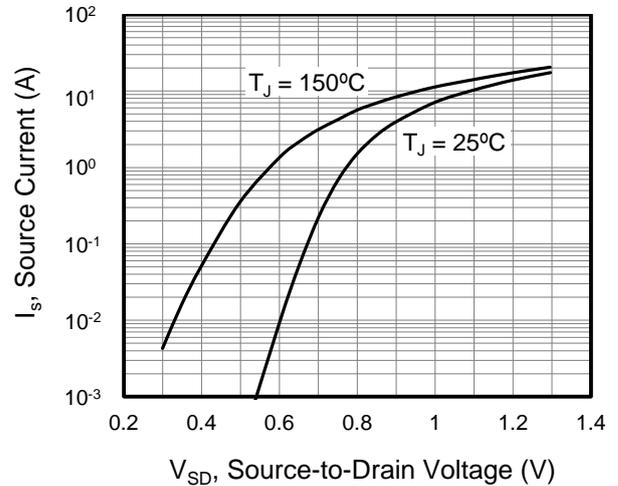


Figure 6. Body Diode Forward Voltage





Typical Characteristics  $T_J = 25^\circ\text{C}$ , unless otherwise noted

Figure 7. On-Resistance vs. Junction Temperature

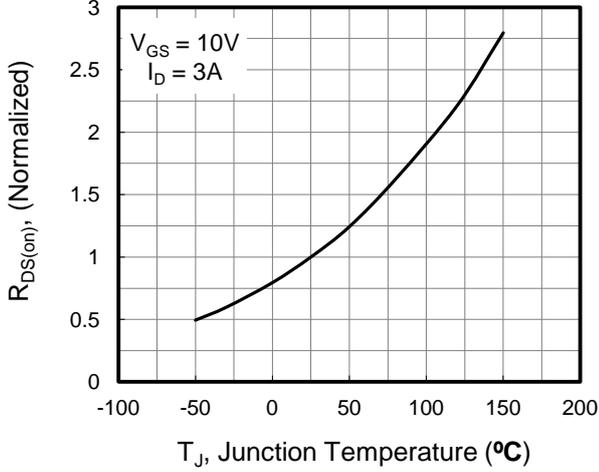


Figure 8. Threshold Voltage vs. Junction Temperature

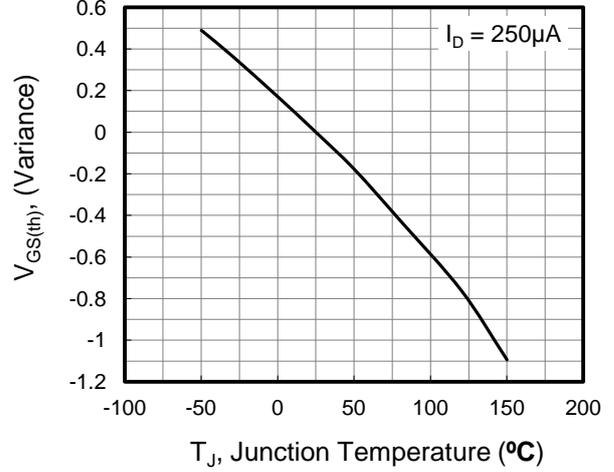


Figure 9. Transient Thermal Impedance TO-220/TO-251/TO-252

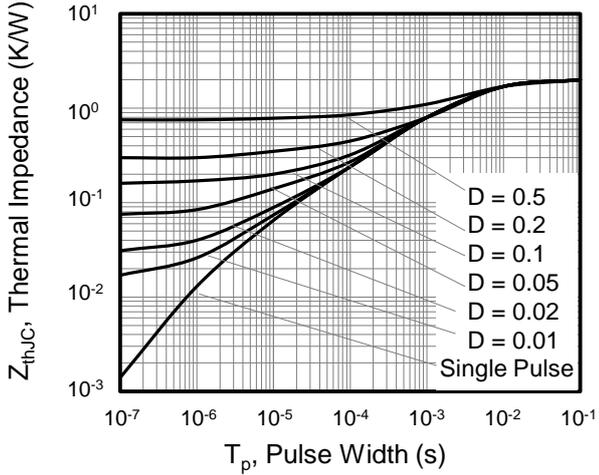


Figure 10. Transient Thermal Impedance TO-220F

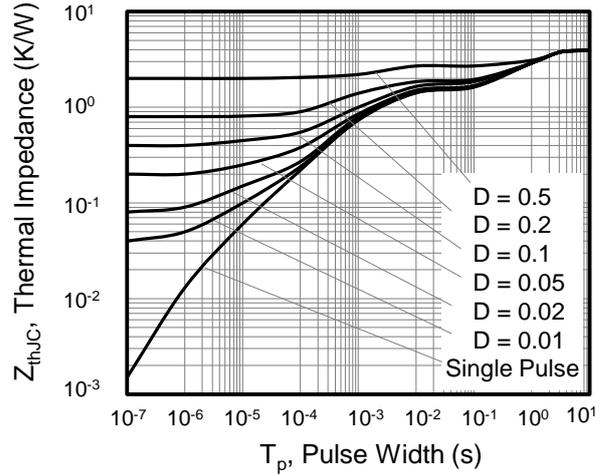


Figure 11. Safe Operating Area TO-220/TO-251/TO-252

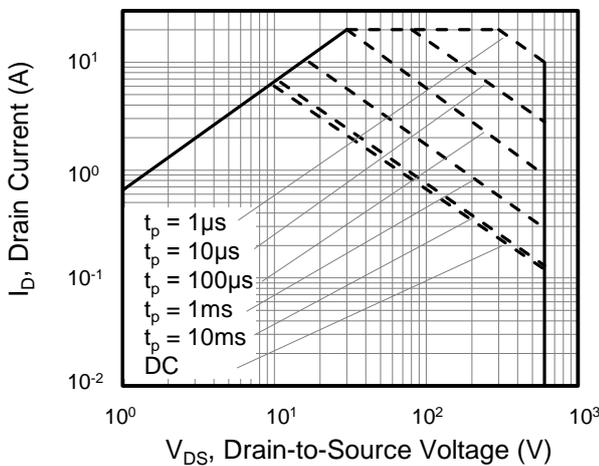


Figure 12. Safe Operating Area TO-220F

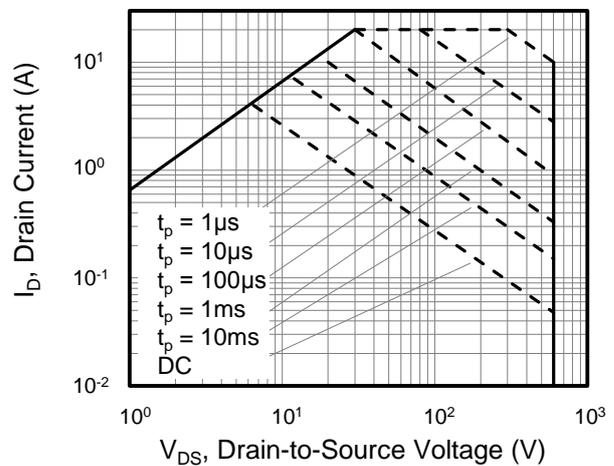




Figure A: Gate Charge Test Circuit and Waveform

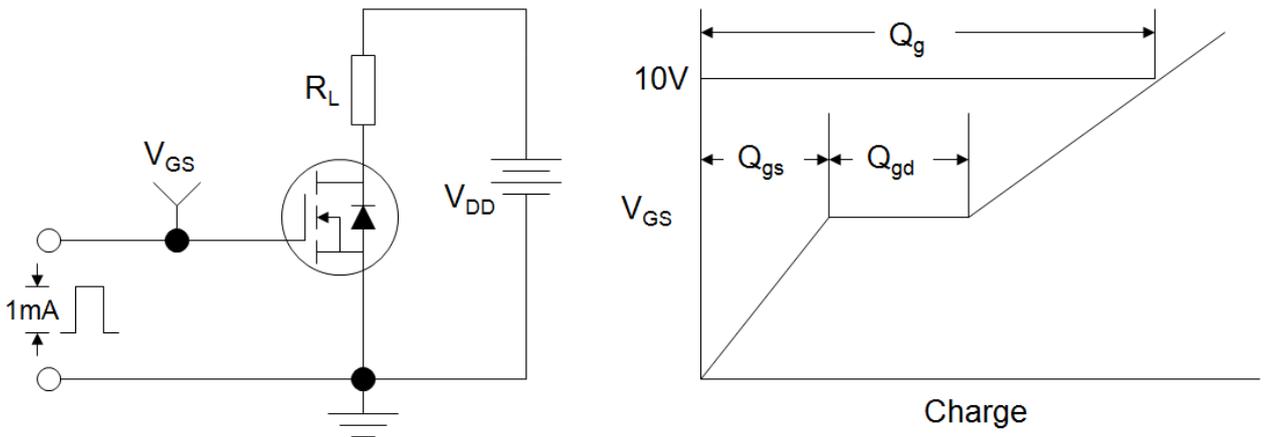


Figure B: Resistive Switching Test Circuit and Waveform

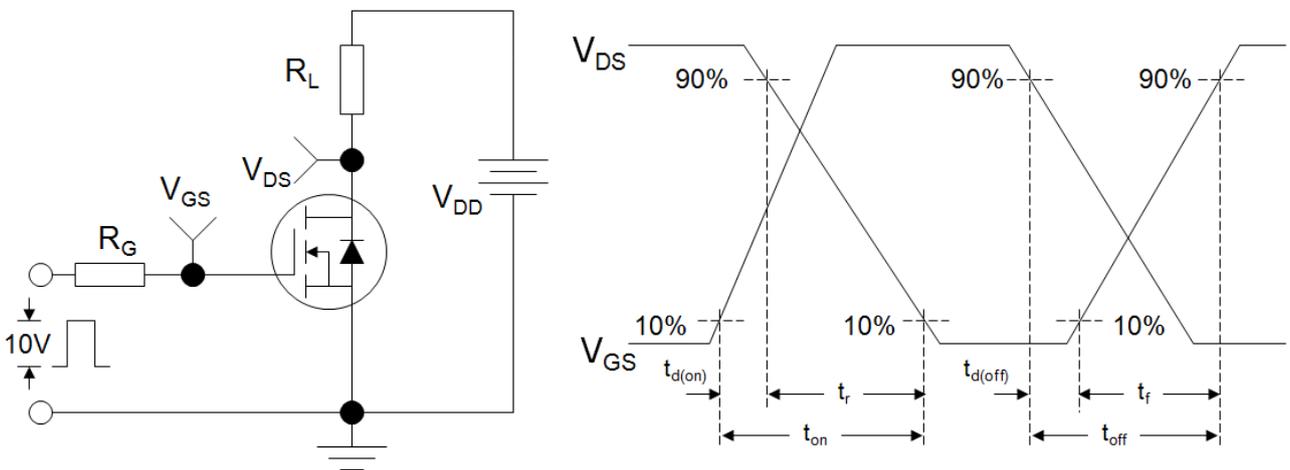
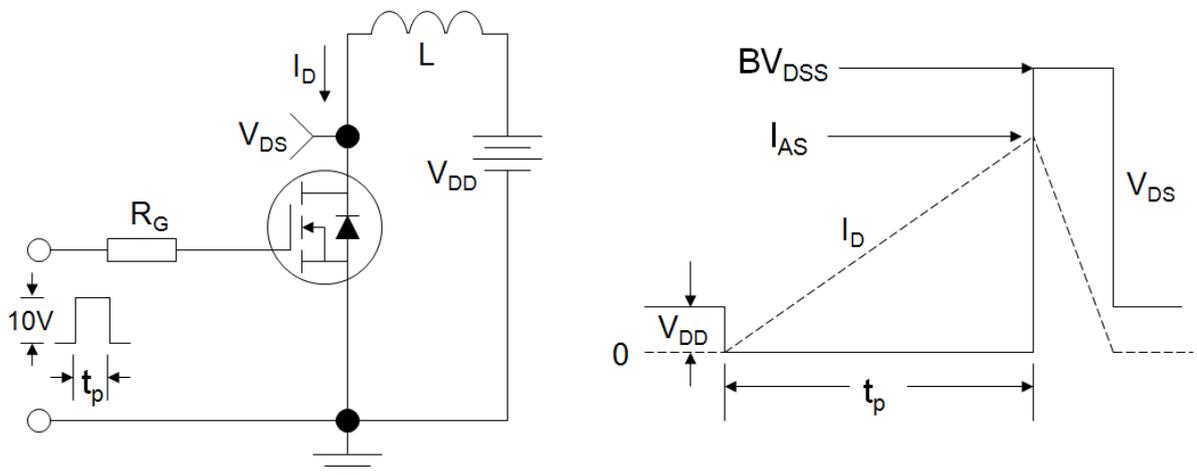


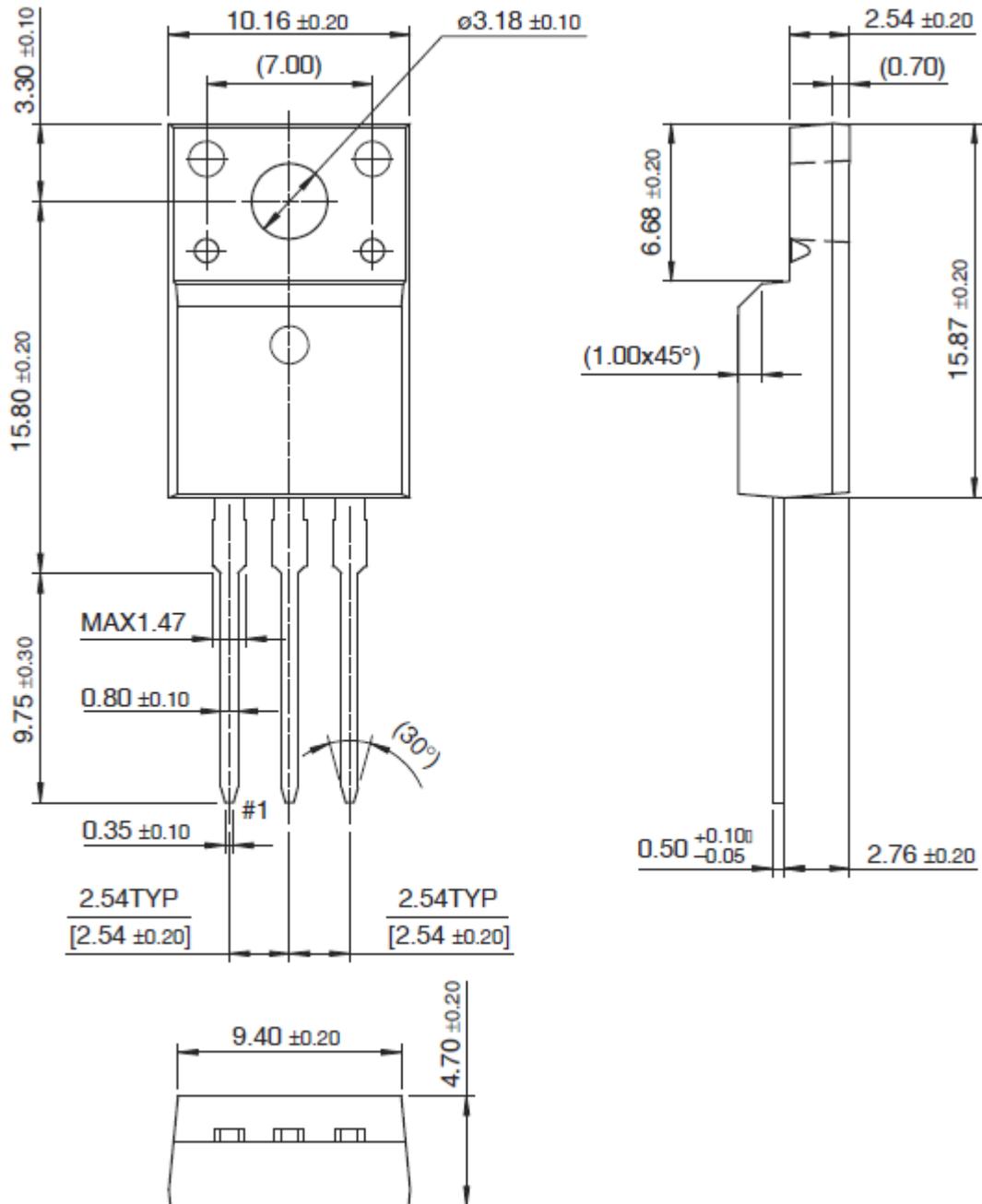
Figure C: Unclamped Inductive Switching Test Circuit and Waveform





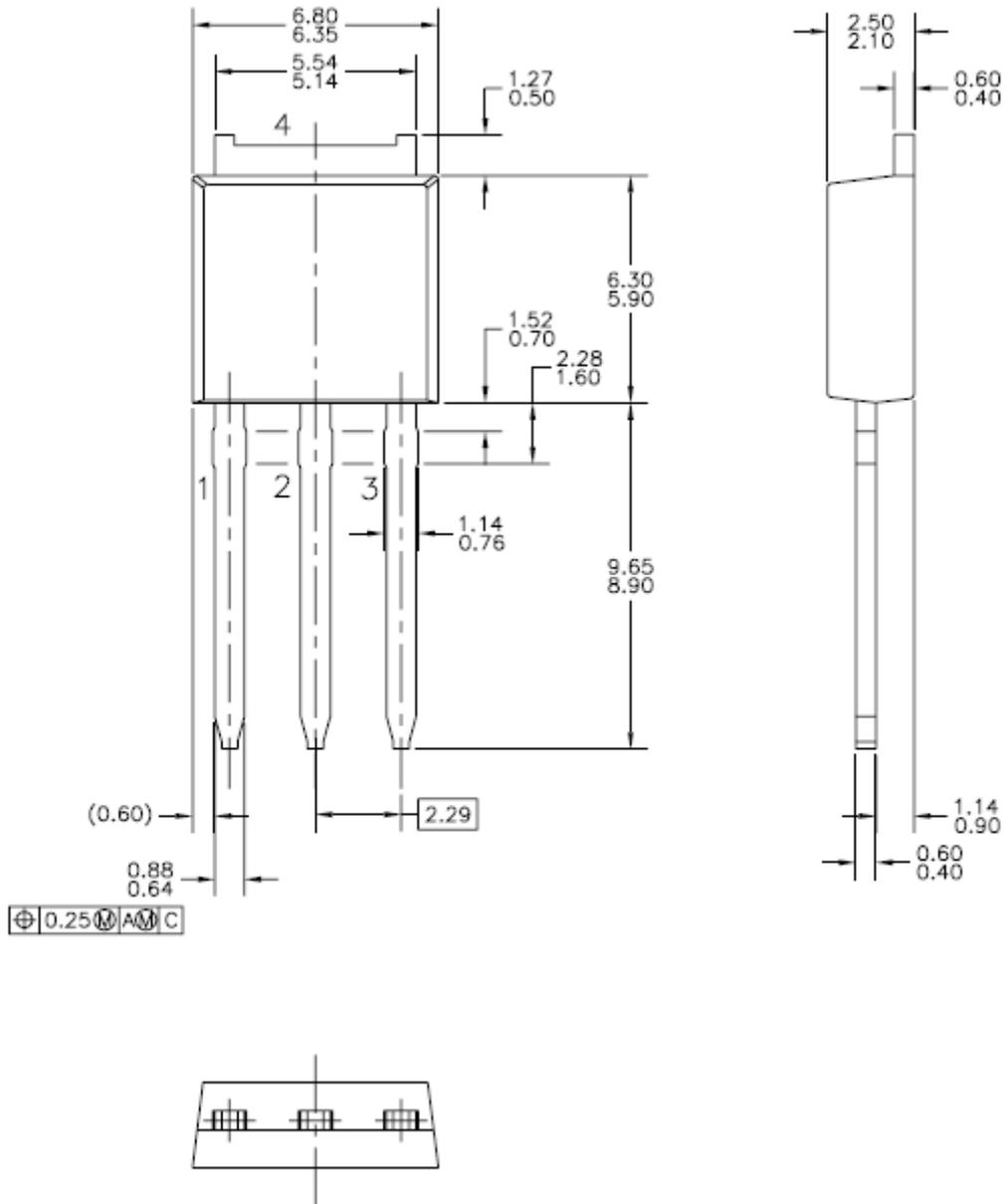


## TO-220F



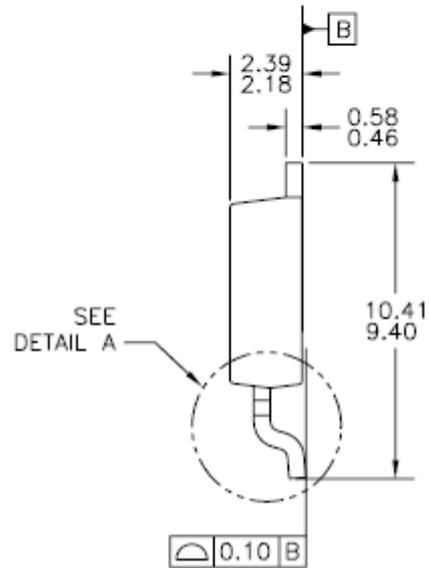
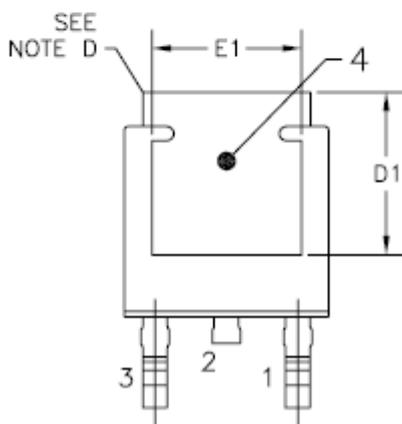
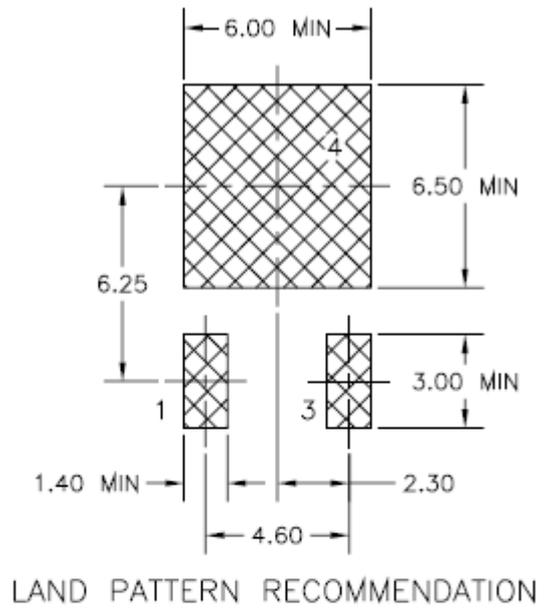
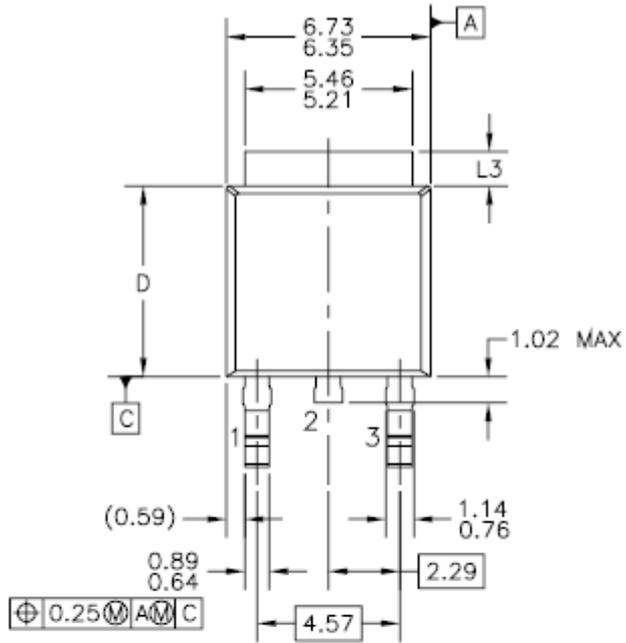


# TO-251





# TO-252





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